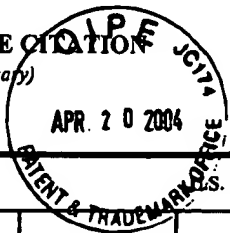


INFORMATION DISCLOSURE CITATION
(Use several sheets if necessary)



| | | | |
|---|--|---|--|
| Docket Number (Optional) OKA-C104 | | Application Number 09/903,764 | |
| Applicant(s) OKU et al | | | |
| Filing Date 13 JULY 2001 | | Group Art Unit 2823 | |

U.S. PATENT DOCUMENTS

| *EXAMINER INITIAL | REF | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
|----------------------|-----|-----------------|----------|--------------|-------|----------|-------------------------------|
| K.N. | | 6,133,162 | 10/17/00 | SUZUKI et al | 438 | 780 | |
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FOREIGN PATENT DOCUMENTS

| | REF | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | Translation | |
|------|-----|-----------------|---------|---------|-------|----------|-------------|----|
| | | | | | | | YES | NO |
| K.N. | | 10-163195 | 6/19/98 | JP | | | | |
| K.N. | | 10-189577 | 7/21/98 | JP | | | | |
| K.N. | | 0 851 480 B1 | 7/24/97 | EP | | | | |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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| EXAMINER <i>Khiem Nguyen</i> | DATE CONSIDERED <i>06/03/04</i> |
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.